







SN74AC14-Q1

SCAS915A - JUNE 2011 - REVISED MAY 2023

SN74AC14-Q1 Hex Schmitt-Trigger Inverter

1 Features

- Qualified for automotive applications
- 2-V to 6-V V_{CC} operation
- Inputs accept voltages to 6 V

2 Description

This Schmitt-trigger device contain six independent inverters. They perform the Boolean function $Y = \overline{A}$.

Package Information

PART NUMBER	PACKAGE ¹	BODY SIZE (NOM)	
SN74AC14-Q1	PW (TSSOP, 14)	5.00 mm x 4.4 mm	

1. For all available packages, see the orderable addendum at the end of the data sheet.



Figure 2-1. Logic Diagram **Each Inverter (Positive Logic)**



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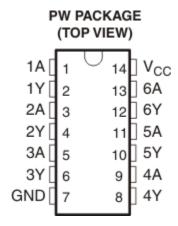
3 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

С	Changes from Revision * (June 2011) to Revision A (May 2023)	Page
•	Added Package Information table, Pin Functions table, and Thermal Information table	1



4 Pin Configuration and Functions



PIN				
NAME	D, DB, N, NS, PW, J, or W	FK	I/O	DESCRIPTION
1A	1	2	Input	Channel 1, Input A
1Y	2	3	Output	Channel 1, Output Y
2A	3	4	Input	Channel 2, Input A
2Y	4	6	Output	Channel 2, Output Y
3A	5	8	Input	Channel 3, Input A
3Y	6	9	Output	Channel 3, Output Y
GND	7	10	_	Ground
4Y	8	12	Output	Channel 4, Output Y
4A	9	13	Input	Channel 4, Input A
5Y	10	14	Output	Channel 5, Output Y
5A	11	16	Input	Channel 5, Input A
6Y	12	18	Output	Channel 6, Output Y
6A	13	19	Input	Channel 6, Input A
V _{CC}	14	20	_	Positive Supply
NC		1, 5, 7, 11, 15, 17	_	Not internally connected

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted(1)

	3 1 3 (MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	7	V
V _I (⁽²⁾)	Input voltage range	-0.5	V _{CC} + 0.5	V	
V _O (⁽²⁾)	Output voltage range		-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	(V _I < 0 or V _I > V _{CC})		±20	mA
I _{OK}	Output clamp current	(V _O < 0 or V _O > V _{CC})		±20	mA
Io	Continuous output current	$(V_O = 0 \text{ to } V_{CC})$		±50	mA
	Continuous current through V _{CC} or GND			±200	mA
T _{stg}	Storage temperature range			150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

5.2 Recommend Operating Conditions

see Note 1

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2	6	V
VI	Input voltage		0	V_{CC}	V
V _O	Output voltage		0	V _{CC}	V
I _{OH}		V _{CC} = 3 V		-12	
	High-level output current	V _{CC} = 4.5 V		-24	mA
		V _{CC} = 5.5 V		-24	
		V _{CC} = 3 V		12	
I _{OL}	Low-level output current	V _{CC} = 4.5 V		24	mA
		V _{CC} = 5.5 V		24	
T _A	Operating free-air temperature	,	-40	125	°C

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

5.3 Thermal Information

	THERMAL METRIC ⁽¹⁾		
			UNIT
		14 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	113	°C/W

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

⁽²⁾ The input and output voltage ratings may be exceeded if the input and output current ratings are observed.



5.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

	TEST SOURITIONS		T,	_A = 25°C		B. A.I. L.	MAY	
PARAMETER	TEST CONDITIONS	V _{CC}	MIN	TYP	MAX	MIN	MAX	UNIT
V _{T+}		3 V	0.8	1.8	2.2	0.8	2.2	
Positive-going		4.5 V	1.5	2.6	3.2	1.5	3.2	V
threshold		5.5 V	1.6	3.2	3.9	1.6	3.9	
V _{T-}		3 V	0.5	8.0	1	0.5	1.2	
Negative-going		4.5 V	0.9	1.4	1.8	0.9	1.8	V
threshold		5.5 V	1.1	1.8	2.3	1.1	2.3	
ΔV_{T}		3 V	0.3	1	1.2	0.3	1.2	
Hysteresis		4.5 V	0.4	1.2	1.4	0.4	1.4	V
(V _{T+} - V _{T-})		5.5 V	0.5	1.4	1.6	0.5	1.6	
		3 V	2.9			2.9		V
	I _{OH} = -50 μA	4.5 V	4.4			4.4		
V		5.5 V	5.4			5.4		
V _{OH}	I _{OH} = -12 mA	3 V	2.56			2.4		
	I _{OH} = -24 mA	4.5 V	3.86			3.7		
		5.5 V	4.86			4.7		
		3 V			0.1		0.1	
	I _{OL} = 50 μA	4.5 V			0.1		0.1	
V		5.5 V			0.1		0.1	
V _{OL}	I _{OL} = 12 mA	3 V			0.36		0.5	V
	1 - 24 mA	4.5 V			0.36		0.5	
	I _{OL} = 24 mA	5.5 V			0.36		0.5	
I _I	V _I = V _{CC} or GND	5.5 V			±0.1		±1	μA
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			2		40	μΑ
Ci	V _I = V _{CC} or GND	5 V		4.5				pF

5.5 Switching Characteristics, V_{CC} = 5 V ± 0.5 V

over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Load Circuit and Voltage Waveforms)

PARAMETER	FROM	то	T _A	= 25°C		MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIN	IVIAA	UNII
t _{PLH}	۸	Y	1.5	5	10	1.5	12	no
t _{PHL}	A		1.5	5	8.5	1.5	10	ns

5.6 Switching Characteristics, V_{CC} = 3.3 V ± 0.3 V

over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Load Circuit and Voltage Waveforms)

PARAMETER	PARAMETER FROM		AMETER FROM TO		T _A :	T _A = 25°C			MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	IVIAA	UNIT		
t _{PLH}	۸	V	1.5	6	13.5	1.0	16	no		
t _{PHL}	A	Y	1.5	6	11.5	1.0	14	ns		



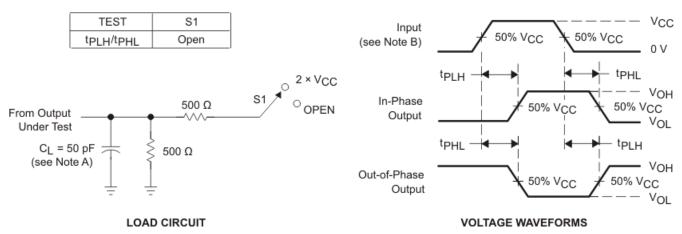
5.7 Operating Characteristics

 V_{CC} = 5 V, T_A = 25°C

	PARAMETER		NDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	C _L = 50 pF,	f = 1 MHz	30	pF



6 Parameter Measurement Information



- A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 6-1. Load Circuit and Voltage Waveforms



7 Detailed Description

7.1 Overview

This Schmitt-trigger device contain six independent inverters. They perform the Boolean function Y = A/. Because of the Schmitt action, they have different input threshold levels for positive-going (V_{T+}) and for negative-going (V_{T-}) signals.

These circuits are temperature compensated and can be triggered from the slowest of input ramps and still give clean, jitter-free output signals. They also have a greater noise margin than conventional inverters.

7.2 Functional Block Diagram



Figure 7-1. Logic Diagram Each Inverter (Positive Logic)

7.3 Device Functional Modes

Table 7-1. Function Table

INPUT	OUTPUT
Α	Y
Н	L
L	н

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN74AC14QPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AC14Q	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN74AC14-Q1:

PACKAGE OPTION ADDENDUM

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Catalog: SN74AC14

• Military : SN54AC14

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ĺ	SN74AC14QPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Ì	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	SN74AC14QPWRQ1	TSSOP	PW	14	2000	356.0	356.0	35.0	

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
 - Sody length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



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